

1200V, 85A, $V_{ce(on)} = 2.5V$ Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT® offers superior ruggedness and ultrafast switching speed.

Features

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current



Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).



MAXIMUM RATINGS

| MAXIMUM RATINGS All Ratings: $T_C = 25$ °C unless otherwis | | | |
|---|--|------------|------|
| Symbol | Parameter | Ratings | Unit |
| V _{ces} | Collector Emitter Voltage | 1200 | V |
| $V_{\rm GE}$ | Gate-Emitter Voltage | ±30 |] |
| I _{C1} | Continuous Collector Current @ T _C = 25°C | 116 | |
| I _{C2} | Continuous Collector Current @ T _c = 70°C | 85 | A |
| I _{CM} | Pulsed Collector Current ① | 240 | |
| SCWT | Short Circuit Withstand Time: V _{CE} = 600V, V _{GE} = 15V, T _C =125°C | 10 | μs |
| $P_{\scriptscriptstyle D}$ | Total Power Dissipation @ T _C = 25°C | 543 | W |
| T _J ,T _{STG} | Operating and Storage Junction Temperature Range | -55 to 150 | °C |
| T _L | Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec. | 300 | |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit |
|----------------------|---|------|-----|------|-------|
| V _{(BR)CES} | Collector-Emitter Breakdown Voltage $(V_{GE} = 0V, I_{C} = 1.0 \text{mA})$ | 1200 | | | |
| V _{GE(TH)} | Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$ | 3.5 | 5.0 | 6.5 | Volts |
| V _{CE(ON)} | Collector-Emitter On Voltage (V_{GE} = 15V, I_{C} = 85A, T_{j} = 25°C) | | 2.5 | 3.2 | |
| | Collector-Emitter On Voltage ($V_{GE} = 15V$, $I_{C} = 85A$, $T_{j} = 125^{\circ}C$) | | 3.3 | | |
| | Collector-Emitter On Voltage ($V_{GE} = 15V$, $I_{C} = 170A$, $T_{j} = 25^{\circ}C$) | | 3.5 | | |
| I _{CES} | Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 25°C) ② | | 10 | 1000 | μA |
| | Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) ② | | 100 | | |
| I _{GES} | Gate-Emitter Leakage Current (V _{GE} = ±20V) | | | ±250 | nA |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

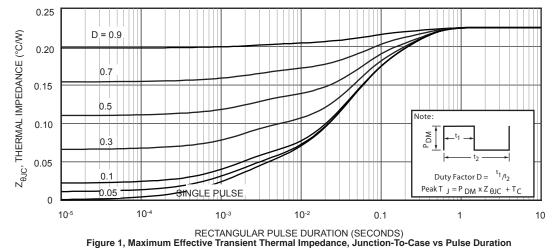
| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------------|---|-----|------|--------|------|
| C _{ies} | Input Capacitance | Capacitance | | 8400 | | |
| C _{oes} | Output Capacitance | $V_{GE} = 0V, V_{CE} = 25V$ | | 725 | | pF |
| C _{res} | Reverse Transfer Capacitance | f = 1MHz | | 190 | | |
| V_{GEP} | Gate to Emitter Plateau Voltage | Cata Charra | | 7.5 | | V |
| Q3 | Total Gate Charge | Gate Charge | | 490 | 660 | |
| Q_ge | Gate-Emitter Charge | V _{GE} = 15V | | 60 | 85 | |
| Q_{gc} | Gate- Collector Charge | $V_{CE} = 600V$ $I_{C} = 85A$ | | 230 | 320 | nC |
| t _{d(on)} | Turn-On Delay Time | Inductive Switching (25°C) | | 43 | | |
| t _r | Current Rise Time | V _{CC} = 600V | | 70 | | 20 |
| $t_{d(off)}$ | Turn-Off Delay Time | V _{GE} = 15V | | 300 | | ns |
| t _f | Current Fall Time | I _C = 85A | | 85 | | |
| E _{on2} ⑤ | Turn-On Switching Energy | $R_{_{\rm G}} = 4.3 \Omega^{(4)}$ | | 6000 | 9000 | 1 |
| E _{off} | Turn-Off Switching Energy | T _J = +25°C | | 3800 | 5700 | μJ |
| t _{d(on)} | Turn-On Delay Time | Inductive Switching (125°C) | | 43 | | |
| t, | Current Rise Time | V _{CC} = 600V | | 70 | | 20 |
| t _{d(off)} | Turn-Off Delay Time | V _{GE} = 15V | | 350 | | ns |
| t _f | Current Fall Time | I _C = 85A | | 95 | | |
| E _{on2} 5 | Turn-On Switching Energy | $R_{_{\rm G}} = 4.3 \ \Omega^{\textcircled{4}}$ | | 7800 | 11,700 | 1 |
| E _{off} | Turn-Off Switching Energy | T _J = +125°C | | 4900 | 7350 | μJ |

THERMAL AND MECHANICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | Min | Тур | Max | Unit |
|----------------------------|--|------|------|------|--------|
| $R_{_{\theta JC}}$ | Junction to Case | - | - | 0.23 | °C/W |
| $W_{\scriptscriptstyle T}$ | Package Weight | - | 1.03 | - | oz |
| Torque | Terminals and Mounting Screws. | - | - | 10 | in∙lbf |
| | | - | - | 1.1 | N·m |
| V | RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.) | 2500 | - | - | Volts |

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width < 380 µs, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- 4 $\,$ R $_{\rm G}$ is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5 E_{on2} is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the
- 6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



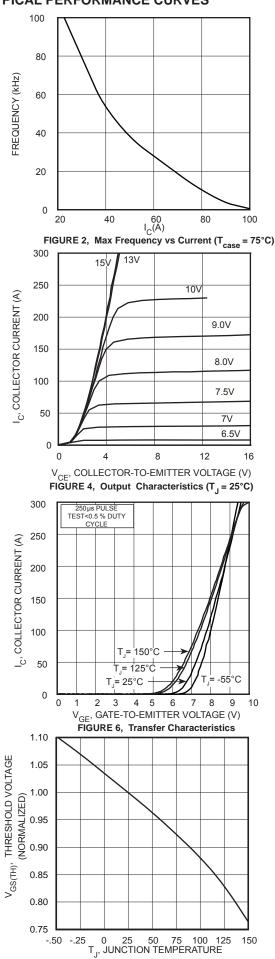
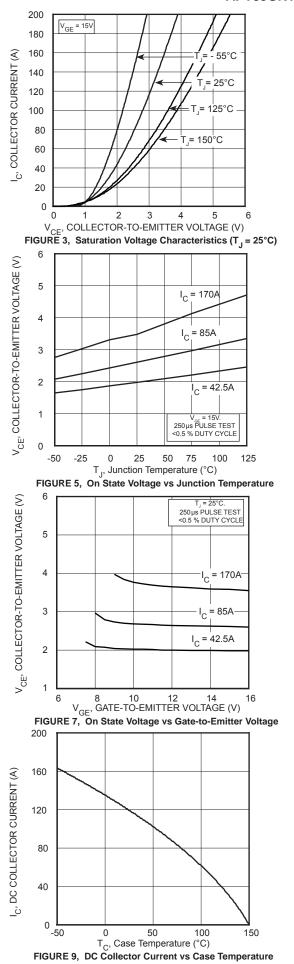


FIGURE 8, Threshold Voltage vs Junction Temperature



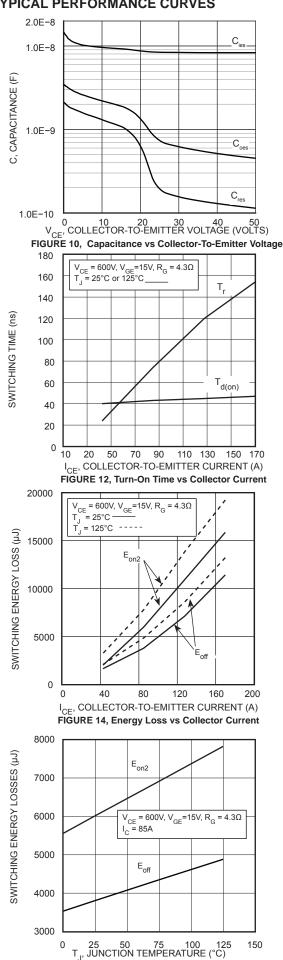
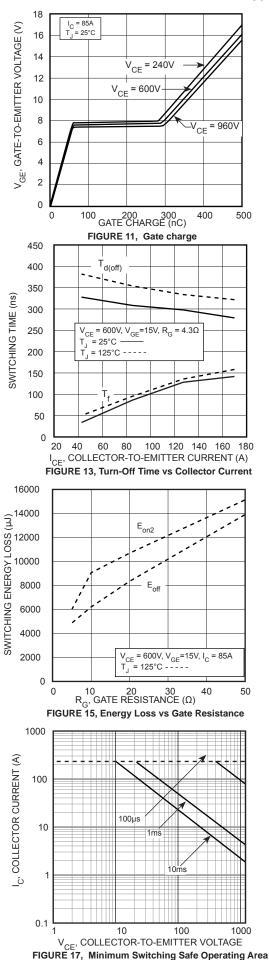
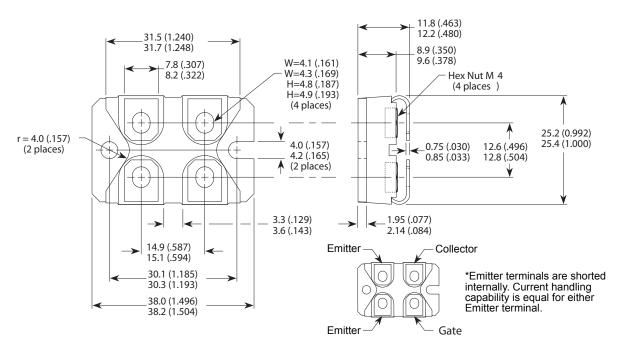


FIGURE 16, Switching Energy vs Junction Temperature



SOT-227 (ISOTOP®) Package Outline



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